

## Errata

# TMS320F28002x Real-Time MCUs Silicon Errata Silicon Revisions A, 0



## ABSTRACT

This document describes the known exceptions to the functional specifications (advisories). This document may also contain usage notes. Usage notes describe situations where the device's behavior may not match presumed or documented behavior. This may include behaviors that affect device performance or functional correctness.

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## 1 Usage Notes and Advisories Matrices

[Table 1-1](#) lists all usage notes and the applicable silicon revision(s). [Table 1-2](#) lists all advisories, modules affected, and the applicable silicon revision(s).

### 1.1 Usage Notes Matrix

**Table 1-1. Usage Notes Matrix**

NUMBER	TITLE	SILICON REVISIONS AFFECTED	
		0	A
<a href="#">Section 3.1.1</a>	PIE: Spurious Nested Interrupt After Back-to-Back PIEACK Write and Manual CPU Interrupt Mask Clear	Yes	Yes
<a href="#">Section 3.1.2</a>	Caution While Using Nested Interrupts	Yes	Yes

### 1.2 Advisories Matrix

**Table 1-2. Advisories Matrix**

MODULE	DESCRIPTION	SILICON REVISIONS AFFECTED	
		0	A
ADC	<a href="#">ADC: Interrupts may Stop if INTxCONT (Continue-to-Interrupt Mode) is not Set</a>	Yes	Yes
ADC	<a href="#">ADC: DMA Read of Stale Result</a>	Yes	Yes
BOR	<a href="#">BOR: VDDIO Between 2.45 V and 3.0 V can Result in Multiple XRSn Pulses</a>	Yes	Yes
DCAN	<a href="#">During DCAN FIFO Mode, Received Messages May be Placed Out of Order in the FIFO Buffer</a>	Yes	Yes
ePWM	<a href="#">ePWM: An ePWM Glitch can Occur if a Trip Remains Active at the End of the Blanking Window</a>	Yes	Yes
ePWM	<a href="#">ePWM: Event Latch (DCxEVTxLAT) of "DC Event-Based CBC Trip" May not Extend Trigger Pulse as Expected When Asynchronous Path is Selected</a>	Yes	No
ePWM	<a href="#">ePWM: Trip Events Will Not be Filtered by the Blanking Window for the First 3 Cycles After the Start of a Blanking Window</a>	Yes	Yes
eQEP	<a href="#">eQEP: Position Counter Incorrectly Reset on Direction Change During Index</a>	Yes	Yes
FPU	<a href="#">FPU: FPU-to-CPU Register Move Operation Preceded by Any FPU 2p Operation</a>	Yes	Yes
Memory	<a href="#">Memory: Prefetching Beyond Valid Memory</a>	Yes	Yes
SYSTEM	<a href="#">SYSTEM: HIC Illegal Read Error Flag Does not Get Asserted in Pagesel=0 Mode</a>	Yes	Yes
SYSTEM	<a href="#">SYSTEM: Multiple Successive Writes to CLKSRCCTL1 Can Cause a System Hang</a>	Yes	Yes

## 2 Nomenclature, Package Symbolization, and Revision Identification

### 2.1 Device and Development-Support Tool Nomenclature

To designate the stages in the product development cycle, TI assigns prefixes to the part numbers of all DSP devices and support tools. Each DSP commercial family member has one of three prefixes: TMX, TMP, or TMS (for example, TMS320F280025C). Texas Instruments recommends two of three possible prefix designators for its support tools: TMDX and TMDS. These prefixes represent evolutionary stages of product development from engineering prototypes (TMX and TMDX) through fully qualified production devices and tools (TMS and TMDS).

Device development evolutionary flow:

**TMX** Experimental device that is not necessarily representative of the final device's electrical specifications and may not use production assembly flow.

**TMP** Prototype device that is not necessarily the final silicon die and may not necessarily meet final electrical specifications.

**TMS** Production version of the silicon die that is fully qualified.

Support tool development evolutionary flow:

**TMDX** Development-support product that has not yet completed Texas Instruments internal qualification testing.

**TMDS** Fully-qualified development-support product.

TMX and TMP devices and TMDX development-support tools are shipped against the following disclaimer:

"Developmental product is intended for internal evaluation purposes."

Production devices and TMDS development-support tools have been characterized fully, and the quality and reliability of the device have been demonstrated fully. TI's standard warranty applies.

Predictions show that prototype devices (X or P) have a greater failure rate than the standard production devices. Texas Instruments recommends that these devices not be used in any production system because their expected end-use failure rate still is undefined. Only qualified production devices are to be used.

### 2.2 Devices Supported

This document supports the following devices:

- [TMS320F280025](#)
- [TMS320F280025C](#)
- [TMS320F280023](#)
- [TMS320F280023C](#)
- [TMS320F280021](#)

### 2.3 Package Symbolization and Revision Identification

Figure 2-1 and Figure 2-2 show the package symbolization. Table 2-1 lists the silicon revision codes.

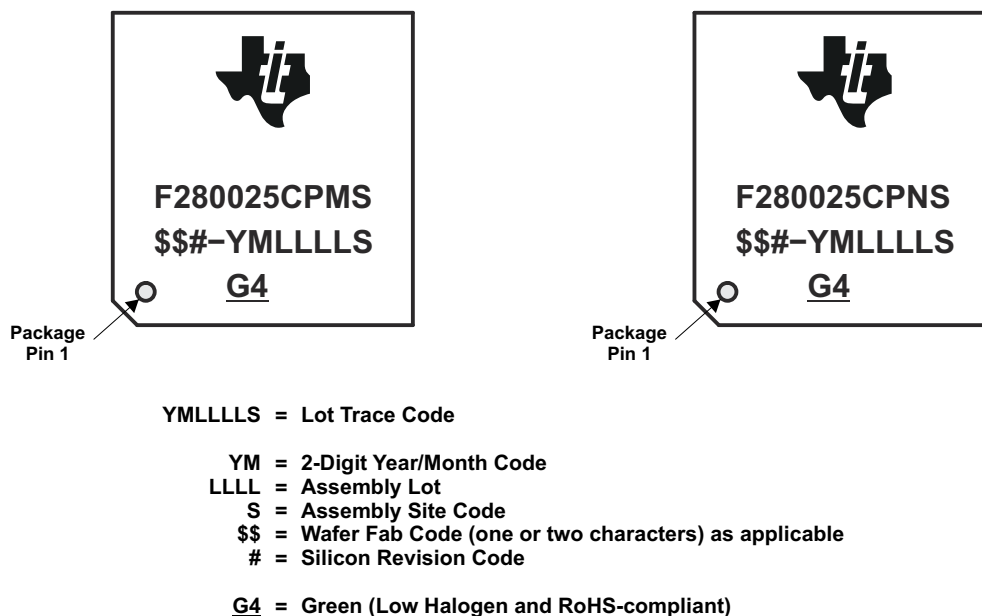


Figure 2-1. Package Symbolization for PM and PN Packages

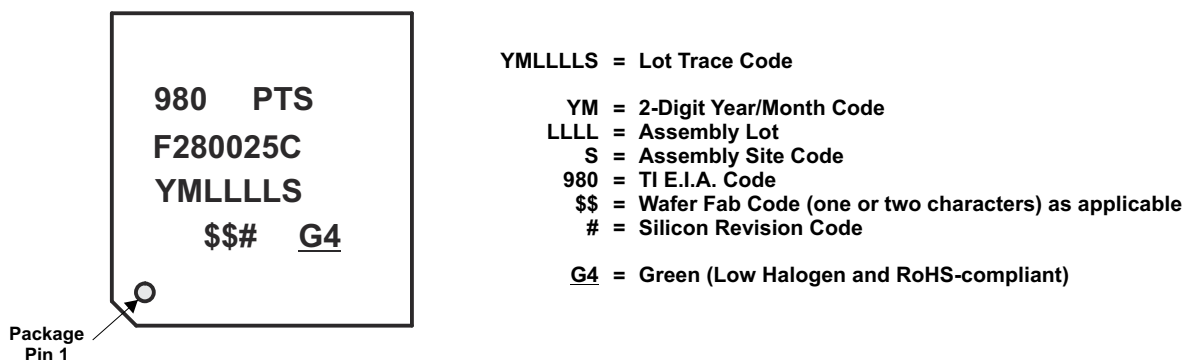


Figure 2-2. Package Symbolization for PT Package

Table 2-1. Revision Identification

SILICON REVISION CODE	SILICON REVISION	REVID <sup>(1)</sup> Address: 0x5D00C	COMMENTS <sup>(2)</sup>
Blank	0	0x0000 0000	This silicon revision is available as TMX.
A	A	0x0000 0001	This silicon revision is available as TMX and TMS.

- (1) Silicon Revision ID
- (2) For orderable device numbers, see the PACKAGING INFORMATION table in the [TMS320F28002x Real-Time Microcontrollers](#) data sheet.

## 3 Silicon Revision A Usage Notes and Advisories

### 3.1 Silicon Revision A Usage Notes

This section lists all the usage notes that are applicable to silicon revision A [and earlier silicon revisions].

#### 3.1.1 PIE: Spurious Nested Interrupt After Back-to-Back PIEACK Write and Manual CPU Interrupt Mask Clear

**Revision(s) Affected:** 0, A

Certain code sequences used for nested interrupts allow the CPU and PIE to enter an inconsistent state that can trigger an unwanted interrupt. The conditions required to enter this state are:

1. A PIEACK clear is followed immediately by a global interrupt enable (EINT or `asm(" CLRC INTM")`).
2. A nested interrupt clears one or more PIEIER bits for its group.

Whether the unwanted interrupt is triggered depends on the configuration and timing of the other interrupts in the system. This is expected to be a rare or nonexistent event in most applications. If it happens, the unwanted interrupt will be the first one in the nested interrupt's PIE group, and will be triggered after the nested interrupt reenables CPU interrupts (EINT or `asm(" CLRC INTM")`).

**Workaround:** Add a NOP between the PIEACK write and the CPU interrupt enable. Example code is shown below.

```
//Bad interrupt nesting code
PieCtrlRegs.PIEACK.all = 0xFFFF;    //Enable nesting in the PIE
EINT;                                //Enable nesting in the CPU

//Good interrupt nesting code
PieCtrlRegs.PIEACK.all = 0xFFFF;    //Enable nesting in the PIE
asm(" NOP");                          //Wait for PIEACK to exit the pipeline
EINT;                                //Enable nesting in the CPU
```

#### 3.1.2 Caution While Using Nested Interrupts

**Revision(s) Affected:** 0, A

If the user is enabling interrupts using the EINT instruction inside an interrupt service routine (ISR) in order to use the nesting feature, then the user must disable the interrupts before exiting the ISR. Failing to do so may cause undefined behavior of CPU execution.

### 3.2 Silicon Revision A Advisories

This section lists all the advisories that are applicable to silicon revision A [and earlier silicon revisions].

#### Advisory **ADC: Interrupts may Stop if INTxCONT (Continue-to-Interrupt Mode) is not Set**

**Revision(s) Affected** 0, A

**Details** If  $ADCINTSELxNx[INTxCONT] = 0$ , then interrupts will stop when the ADCINTFLG is set and no additional ADC interrupts will occur.

When an ADC interrupt occurs simultaneously with a software write of the ADCINTFLGCLR register, the ADCINTFLG will unexpectedly remain set, blocking future ADC interrupts.

**Workaround(s)** 1. Use Continue-to-Interrupt Mode to prevent the ADCINTFLG from blocking additional ADC interrupts:

```
ADCINTSEL1N2[INT1CONT] = 1;
ADCINTSEL1N2[INT2CONT] = 1;
ADCINTSEL3N4[INT3CONT] = 1;
ADCINTSEL3N4[INT4CONT] = 1;
```

2. Ensure there is always sufficient time to service the ADC ISR and clear the ADCINTFLG before the next ADC interrupt occurs to avoid this condition.
3. Check for an overflow condition in the ISR when clearing the ADCINTFLG. Check ADCINTOVF immediately after writing to ADCINTFLGCLR; if it is set, then write ADCINTFLGCLR a second time to ensure the ADCINTFLG is cleared. The ADCINTOVF register will be set, indicating an ADC conversion interrupt was lost.

```
AdcaRegs.ADCINTFLGCLR.bit.ADCINT1 = 1;           //clear INT1 flag
if(1 == AdcaRegs.ADCINTOVF.bit.ADCINT1)         //ADCINT overflow
{
    AdcaRegs.ADCINTFLGCLR.bit.ADCINT1 = 1;       //clear INT1 again
    // If the ADCINTOVF condition will be ignored by the application
    // then clear the flag here by writing 1 to ADCINTOVFCLR.
    // If there is a ADCINTOVF handling routine, then either insert
    // that code and clear the ADCINTOVF flag here or do not clear
    // the ADCINTOVF here so the external routine will detect the
    // condition.
    // AdcaRegs.ADCINTOVFCLR.bit.ADCINT1 = 1;    // clear OVF
}
```

**Advisory** **ADC: DMA Read of Stale Result**


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**Revision(s) Affected** 0, A

**Details**

The ADCINT flag can be set before the ADCRESULT value is latched (see the  $t_{LAT}$  and  $t_{INT(LATE)}$  columns in the ADC Timings table of the [TMS320F28002x Real-Time Microcontrollers](#) data sheet). The DMA can read the ADCRESULT value as soon as 3 cycles after the ADCINT trigger is set. As a result, the DMA could read a prior ADCRESULT value when the user expects the latest result if all of the following are true:

- The ADC is in late interrupt mode.
- The ADC operates in a mode where  $t_{INT(LATE)}$  occurs 3 or more cycles before  $t_{LAT}$  ( $ADCCTL2 [PRESCALE] > 2$ ).
- The DMA is triggered from the ADCINT signal.
- The DMA immediately reads the ADCRESULT value associated with that ADCINT signal without reading any other values first.
- The DMA was idle when it received the ADCINT trigger.

Only the DMA reads listed above could result in reads of stale data; the following non-DMA methods will always read the expected data:

- The ADCINT flag triggers a CLA task.
- The ADCINT flag triggers a CPU ISR.
- The CPU polls the ADCINT flag.

**Workaround(s)**

Trigger two DMA channels from the ADCINT flag. The first channel acts as a dummy transaction. This will result in enough delay that the second channel will always read the fresh ADC result.

**Advisory** **BOR: VDDIO Between 2.45 V and 3.0 V can Result in Multiple XRSn Pulses**

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**Revision(s) Affected** 0, A**Details** The BOR can generate repeating XRSn assertions and deassertions when the VDDIO supply voltage is between 2.45 V and 3.0 V. It is recommended that the XRSn pin *not* be used directly as a reset to any other devices in the system.

The F28002x BOR is effective for internally holding the device in a known reset state, even when these XRSn pulses are occurring. The device will not branch to application code or bootloaders, and all other pins will be held in their reset state until the VDDIO supply rises above 3.0 V.

- Workaround(s)**
1. Ignore the extra XRSn transitions during power up, power down, and BOR events. The extra XRSn pulses will have no effect on the F28002x device operation itself.
  2. If XRSn pulses would cause undesired system behavior with other system components, then do not use XRSn to drive other devices. An external voltage supervisor can be used for these applications.
  3. For applications that need to avoid these pulses during normal power up and power down:
    - a. Power up: Follow the  $t_{VDDIO-RAMP}$  requirement in the Recommended Operating Conditions table of the [TMS320F28002x Real-Time Microcontrollers](#) data sheet; no extra XRSn low pulses will occur.
    - b. Power Down: To avoid any deassertion of XRSn during power down, design the power supply so that VDDIO passes through the range from 3.0 V to 2.45 V within 25  $\mu$ s. If some voltage rise on XRSn is acceptable, then the time constant of the RC circuit implemented on XRSn can be calculated to ensure the voltage does not rise above a system-specified threshold.



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**Advisory**                    ***During DCAN FIFO Mode, Received Messages May be Placed Out of Order in the FIFO Buffer***

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**Revision(s) Affected** 0, A

**Details**                    In DCAN FIFO mode, received messages with the same arbitration and mask IDs are supposed to be placed in the FIFO in the order in which they are received. The CPU then retrieves the received messages from the FIFO via the IF1/IF2 interface registers. Some messages may be placed in the FIFO out of the order in which they were received. If the order of the messages is critical to the application for processing, then this behavior will prevent the proper use of the DCAN FIFO mode.

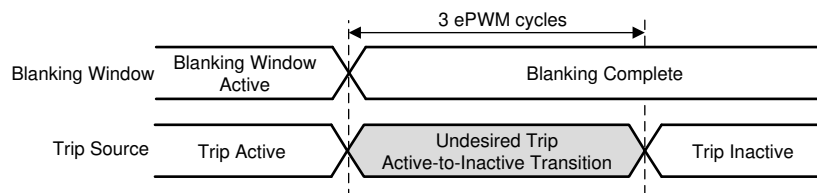
**Workaround(s)**            Use the DMA to read out the FIFO via the IF3 register. Each time a message is received into the FIFO, the data is also copied to the IF3 register, and a DMA request is generated to the DMA module to read out the data.

**Advisory** ***ePWM: An ePWM Glitch can Occur if a Trip Remains Active at the End of the Blanking Window***

**Revision(s) Affected** 0, A

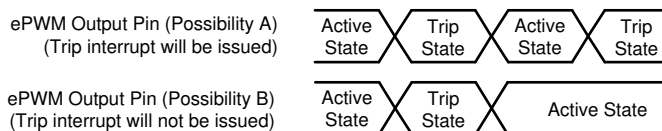
**Details** The blanking window is typically used to mask any PWM trip events during transitions which would be false trips to the system. If an ePWM trip event remains active for less than three ePWM clocks after the end of the blanking window cycles, there can be an undesired glitch at the ePWM output.

Figure 3-1 illustrates the time period which could result in an undesired ePWM output.



**Figure 3-1. Undesired Trip Event and Blanking Window Expiration**

Figure 3-2 illustrates the two potential ePWM outputs possible if the trip event ends within 1 cycle before or 3 cycles after the blanking window closes.



**Figure 3-2. Resulting Undesired ePWM Outputs Possible**

**Workaround(s)** Extend or reduce the blanking window to avoid any undesired trip action.

**Advisory** ***ePWM: Trip Events Will Not be Filtered by the Blanking Window for the First 3 Cycles After the Start of a Blanking Window***

**Revisions Affected** 0, A

**Details** The Blanking Window will not blank trip events for the first 3 cycles after the start of a Blanking Window. DCEVTFILT may continue to reflect changes in the DCxEVty signals. If DCEVTFILT is enabled, this may impact subsequent subsystems that are configured (for example, the Trip Zone submodule, TZ interrupts, ADC SOC, or the PWM output).

**Workaround** Start the Blanking Window 3 cycles before blanking is required. If a Blanking Window is needed at a period boundary, start the Blanking Window 3 cycles before the beginning of the next period. This works because Blanking Windows persist across period boundaries.

**Advisory** **eQEP: Position Counter Incorrectly Reset on Direction Change During Index**
**Revision(s) Affected** 0, A

**Details**

While using the PCRM = 0 configuration, if the direction change occurs when the index input is active, the position counter (QPOSCNT) could be reset erroneously, resulting in an unexpected change in the counter value. This could result in a change of up to  $\pm 4$  counts from the expected value of the position counter and lead to unexpected subsequent setting of the error flags.

While using the PCRM = 0 configuration [that is, Position Counter Reset on Index Event (QEPCTL[PCRM] = 00)], if the index event occurs during the forward movement, then the position counter is reset to 0 on the next eQEP clock. If the index event occurs during the reverse movement, then the position counter is reset to the value in the QPOSMAX register on the next eQEP clock. The eQEP peripheral records the occurrence of the first index marker (QEPSTS[FIMF]) and direction on the first index event marker (QEPSTS[FIDF]) in QEPSTS registers. It also remembers the quadrature edge on the first index marker so that same relative quadrature transition is used for index event reset operation.

If the direction change occurs while the index pulse is active, the module would still continue to look for the relative quadrature transition for performing the position counter reset. This results in an unexpected change in the position counter value.

The next index event without a simultaneous direction change will reset the counter properly and work as expected.

**Workaround(s)**

Do not use the PCRM = 0 configuration if the direction change could occur while the index is active and the resultant change of the position counter value could affect the application.

Other options for performing position counter reset, if appropriate for the application [such as Index Event Initialization (IEI)], do not have this issue.

**Advisory**
**FPU: FPU-to-CPU Register Move Operation Preceded by Any FPU 2p Operation**
**Revision(s) Affected** 0, A

**Details**

This advisory applies when a multi-cycle (2p) FPU instruction is followed by a FPU-to-CPU register transfer. If the FPU-to-CPU read instruction source register is the same as the 2p instruction destination, then the read may be of the value of the FPU register before the 2p instruction completes. This occurs because the 2p instructions rely on data-forwarding of the result during the E3 phase of the pipeline. If a pipeline stall happens to occur in the E3 phase, the result does not get forwarded in time for the read instruction.

The 2p instructions impacted by this advisory are MPYF32, ADDF32, SUBF32, and MACF32. The destination of the FPU register read must be a CPU register (ACC, P, T, XAR0...XAR7). This advisory does not apply if the register read is a FPU-to-FPU register transfer.

In the example below, the 2p instruction, MPYF32, uses R6H as its destination. The FPU register read, MOV32, uses the same register, R6H, as its source, and a CPU register as the destination. If a stall occurs in the E3 pipeline phase, then MOV32 will read the value of R6H before the MPYF32 instruction completes.

**Example of Problem:**

```

MPYF32 R6H, R5H, R0H ; 2p FPU instruction that writes to R6H
|| MOV32 *XAR7++, R4H
F32TOUI16R R3H, R4H ; delay slot
ADDF32 R2H, R2H, R0H
|| MOV32 *--SP, R2H ; alignment cycle
MOV32 @XAR3, R6H ; FPU register read of R6H
    
```

Figure 3-3 shows the pipeline diagram of the issue when there are no stalls in the pipeline.

	Instruction	F1	F2	D1	D2	R1	R2	E	W	Comments	
		FPU pipeline-->					R1	R2	E1		E2
I1	MPYF32 R6H, R5H, R0H    MOV32 *XAR7++, R4H	I1									
I2	F32TOUI16R R3H, R4H	I2	I1								
I3	ADDF32 R3H, R2H, R0H    MOV32 *--SP, R2H	I3	I2	I1							
I4	MOV32 @XAR3, R6H	I4	I3	I2	I1						
			I4	I3	I2	I1					
				I4	I3	I2	I1				
					I4	I3	I2	I1			
						I4	I3	I2	I1		I4 samples the result as it enters the R2 phase. The product R6H=R5H*R0H (I1) finishes computing in the E3 phase, but is <b>forwarded</b> as an operand to I4. This makes I4 appear to be a 2p instruction, but I4 actually takes 3p cycles to compute.
							I4	I3	I2		
								I4	I3		

**Figure 3-3. Pipeline Diagram of the Issue When There are no Stalls in the Pipeline**

Figure 3-4 shows the pipeline diagram of the issue if there is a stall in the E3 slot of the instruction I1.

Instruction	F1	F2	D1	D2	R1	R2	E	W	Comments	
	FPU pipeline-->				R1	R2	E1	E2		E3
I1 MPYF32 R6H, R5H, R0H    MOV32 *XAR7++, R4H	I1									
I2 F32TOUI16R R3H, R4H	I2	I1								
I3 ADDF32 R3H, R2H, R0H    MOV32 *--SP, R2H	I3	I2	I1							
I4 MOV32 @XAR3, R6H	I4	I3	I2	I1						
		I4	I3	I2	I1					
			I4	I3	I2	I1				
				I4	I3	I2	I1			
					I4	I3	I2	I1		I4 samples the result as it enters the R2 phase, but I1 is stalled in E3 and is unable to forward the product of R5H*R0H to I4 (R6H does not have the product yet due to a design bug). So, I4 reads the old value of R6H.
						I4	I3	I2	I1	There is no change in the pipeline as it was stalled in the previous cycle. I4 had already sampled the old value of R6H in the previous cycle.
							I4	I3	I2	Stall over

**Figure 3-4. Pipeline Diagram of the Issue if There is a Stall in the E3 Slot of the Instruction I1**

**Workaround(s)**

Treat MPYF32, ADDF32, SUBF32, and MACF32 in this scenario as 3p-cycle instructions. Three NOPs or non-conflicting instructions must be placed in the delay slot of the instruction.

The C28x Code Generation Tools v.6.2.0 and later will both generate the correct instruction sequence and detect the error in assembly code. In previous versions, v6.0.5 (for the 6.0.x branch) and v.6.1.2 (for the 6.1.x branch), the compiler will generate the correct instruction sequence but the assembler will not detect the error in assembly code.

**Example of Workaround:**

```

MPYF32 R6H, R5H, R0H
|| MOV32 *XAR7++, R4H ; 3p FPU instruction that writes to R6H
F32TOUI16R R3H, R4H ; delay slot
ADDF32 R2H, R2H, R0H
|| MOV32 *--SP, R2H ; delay slot
NOP ; alignment cycle
MOV32 @XAR3, R6H ; FPU register read of R6H
    
```

Figure 3-5 shows the pipeline diagram with the workaround in place.

	Instruction	F1	F2	D1	D2	R1	R2	E	W	Comments	
		FPU pipeline-->					R1	R2	E1		E2
I1	MPYF32 R6H, R5H, R0H    MOV32 *XAR7++, R4H	I1									
I2	F32TOUI16R R3H, R4H	I2	I1								
I3	ADDF32 R3H, R2H, R0H    MOV32 *--SP, R2H	I3	I2	I1							
I4	NOP	I4	I3	I2	I1						
I5	MOV32 @XAR3, R6H	I5	I4	I3	I2	I1					
			I5	I4	I3	I2	I1				
				I5	I4	I3	I2	I1			
					I5	I4	I3	I2	I1 (STALL)	Due to one extra NOP, I5 does not reach R2 when I1 enters E3; thus, forwarding is not needed.	
					I5	I4	I3	I2	I1	There is no change due to the stall in the previous cycle.	
						I5	I4	I3	I2	I1 moves out of E3 and I5 moves to R2. R6H has the result of R5H*R0H and is read by I5. There is no need to forward the result in this case.	
							I5	I4	I3		

**Figure 3-5. Pipeline Diagram With Workaround in Place**

**Advisory** **Memory: Prefetching Beyond Valid Memory**


---

**Revision(s) Affected** 0, A

**Details** The C28x CPU prefetches instructions beyond those currently active in its pipeline. If the prefetch occurs past the end of valid memory, then the CPU may receive an invalid opcode.

**Workaround** **M1, GS3** – The prefetch queue is 8 x16 words in depth. Therefore, code should not come within 8 words of the end of valid memory. Prefetching across the boundary between two valid memory blocks is all right.

Example 1: M1 ends at address 0x7FF and is not followed by another memory block. Code in M1 should be stored no farther than address 0x7F7. Addresses 0x7F8–0x7FF should not be used for code.

Example 2: M0 ends at address 0x3FF and valid memory (M1) follows it. Code in M0 can be stored up to and including address 0x3FF. Code can also cross into M1, up to and including address 0x7F7.

**Flash** – The prefetch queue is 16 x16 words in depth. Therefore, code should not come within 16 words of the end of valid memory; otherwise, it generates a Flash ECC uncorrectable error.

**Table 3-1. Memories Impacted by Advisory**

MEMORY TYPE	ADDRESSES IMPACTED
M1	0x0000 07F8–0x0000 07FF
GS3	0x0000 C7F8–0x0000 C7FF
Flash	0x0008 FFF0–0x0008 FFFF

<b>Advisory</b>	<b><i>SYSTEM: HIC Illegal Read Error Flag Does not Get Asserted in Pagesel=0 Mode</i></b>
<hr/>	
<b>Revisions Affected</b>	0, A
<b>Details</b>	When a Host Read access is initiated to the same address of a pending write location (an illegal access sequence), the Illegal Read error flag does not get asserted in Pagesel=0 Mode. The error flag gets set for the same sequence in Pagesel=1 mode. The impact is low since it is an illegal sequence and SW is not expected to initiate a read to a write-pending location in the regular application flow.
<b>Workaround</b>	None

<b>Advisory</b>	<b><i>SYSTEM: Multiple Successive Writes to CLKSRCCTL1 Can Cause a System Hang</i></b>
<hr/>	
<b>Revision(s) Affected</b>	0, A
<b>Details</b>	<p>When the CLKSRCCTL1 register is written more than once without delay between writes, the system can hang and can only be recovered by an external XRSn reset or Watchdog reset. The occurrence of this condition depends on the clock ratio between SYSCLK and the clock selected by OSCCLKSRCSEL, and may not occur every time.</p> <p>If this issue is encountered while using the debugger, then after hitting pause, the program counter will be at the Boot ROM reset vector.</p> <p>Implementing the workaround will avoid this condition for any SYSCLK to OSCCLK ratio.</p>
<b>Workaround(s)</b>	<p>Add a software delay of 300 SYSCLK cycles using an NOP instruction after every write to the CLKSRCCTL1 register.</p> <p>Example:</p>

```

ClkCfgRegs.CLKSRCCTL1.bit.INTOSC2OFF=0;           // Turn on INTOSC2
asm(" RPT #250 || NOP");                          // Delay of 250 SYSCLK Cycles
asm(" RPT #50 || NOP");                           // Delay of 50 SYSCLK Cycles
ClkCfgRegs.CLKSRCCTL1.bit.OSCCLKSRCSEL = 0;       // Clk Src = INTOSC2
asm(" RPT #250 || NOP");                          // Delay of 250 SYSCLK Cycles
asm(" RPT #50 || NOP");                           // Delay of 50 SYSCLK Cycles
    
```

C2000Ware\_3\_00\_00\_00 and later revisions will have this workaround implemented.



## 4 Silicon Revision 0 Usage Notes and Advisories

### 4.1 Silicon Revision 0 Usage Notes

Silicon revision-applicable usage notes have been found on a later silicon revision. For more details, see [Section 3.1](#).

### 4.2 Silicon Revision 0 Advisories

Silicon revision-applicable advisories have been found on a later silicon revision. For more details, see [Section 3.2](#).

<b>Advisory</b>	<b><i>ePWM: Event Latch (DCxEVTxLAT) of "DC Event-Based CBC Trip" May not Extend Trigger Pulse as Expected When Asynchronous Path is Selected</i></b>
<b>Revision(s) Affected</b>	0
<b>Details</b>	DCxEVTxLAT may lose the captured trigger event for an asynchronous input upon deassertion. When an asynchronous trigger is deasserted, it is expected that the flop holds the value until there is a Clear event. Since the trigger is asynchronous with respect to the clock of the flop, there is a possibility that the flop may get cleared during deassertion. This would result in a loss of event latch function.
<b>Workaround(s)</b>	None

## 5 Documentation Support

For device-specific data sheets and related documentation, visit the TI web site at: <https://www.ti.com>.

For more information regarding the TMS320F28002x devices, see the following documents:

- [TMS320F28002x Real-Time Microcontrollers](#) data sheet
- [TMS320F28002x Real-Time Microcontrollers Technical Reference Manual](#)

## 6 Trademarks

All other trademarks are the property of their respective owners.

## 7 Revision History

### Changes from March 17, 2020 to October 3, 2020 (from Revision \* (March 2020) to Revision A (October 2020))

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• Updated the numbering format for tables, figures, and cross-references throughout the document.....	2
• <b>Global:</b> Added data for silicon revision A.....	2
• <b>Global:</b> Removed TMS320F280024, TMS320F280024C, and TMS320F280022.....	2
• <a href="#">Figure 2-1</a> (Package Symbolization for PM and PN Packages): Updated figure.....	4
• <a href="#">Figure 2-2</a> (Package Symbolization for PT Package): Updated figure.....	4
• <a href="#">Table 2-1</a> (Revision Identification): Updated table.....	4
• Added <a href="#">ePWM: Trip Events Will Not be Filtered by the Blanking Window for the First 3 Cycles After the Start of a Blanking Window</a> advisory.....	10
• Added <a href="#">SYSTEM: HIC Illegal Read Error Flag Does not Get Asserted in Pagesel=0 Mode</a> advisory.....	16

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